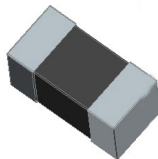


MFBA2V2012

Automotive multilayer chip ferrite bead



Product features

- AEC-Q200 qualified
- Multilayer monolithic construction yields high reliability
- 0805 (2012 metric) surface mount package
- Ultra-low direct current resistance (DCR)
- Impedance range: 30 ohms to 600 ohms
- Moisture sensitivity level (MSL): 1

Applications

- Body electronics (keyless entry, ECU, antennas)
- Advanced driver assistance systems (ADAS)
- Infotainment and cluster electronics
- Safety electronics systems
- WLAN, WiFi, Bluetooth
- Portable medical devices
- Inventory management equipment
- Displays/monitors
- IoT, remote monitoring
- Testing equipment
- Automation equipment
- Sensors

Environmental compliance and general specifications

- Operating temperature range: -55 °C to +150 °C (ambient plus self-temperature rise)
- Storage temperature (component): -55 °C to +150 °C
- Solder reflow temperature: J-STD-020 (latest revision) compliant



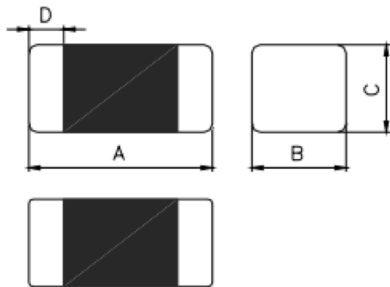
Product specifications

Part number ²	Impedance (Ω) 100 MHz, $\pm 25\%$, @ +25°C	DCR (Ω) maximum @ +25°C	Rated current ¹ (mA) maximum
MFBA2V2012-300-R	30	0.04	3000
MFBA2V2012-800-R	80	0.04	3000
MFBA2V2012-121-R	120	0.1	2000
MFBA2V2012-151-R	150	0.1	2000
MFBA2V2012-221-R	220	0.1	2000
MFBA2V2012-301-R	300	0.2	1000
MFBA2V2012-601-R	600	0.2	1000

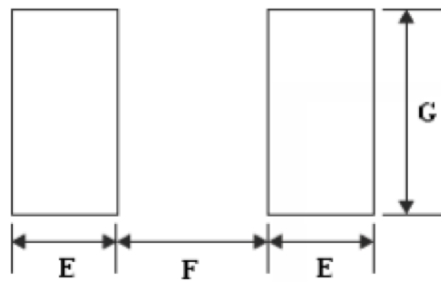
1. Rated current: Current rating for an approximate self-temperature rise of 40 °C or less.

2. Part number definition: MFBA2V2012-xxx-R
MFBA2V2012 = Product code and size
xxx = Impedance value in Ω , last character equals number of zeros
-R suffix = RoHS compliant

Mechanical parameters (mm)



Recommended pad layout



Schematic



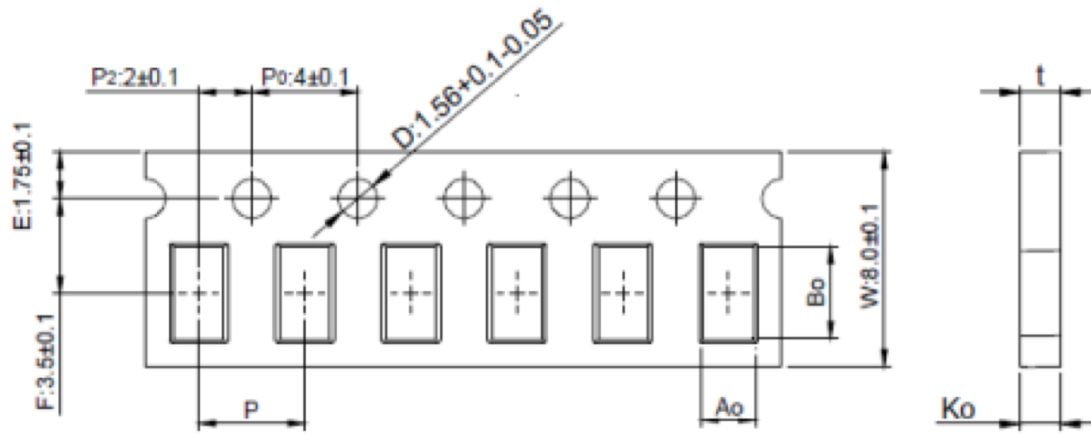
Part number	A	B	C	D	E (ref.)	F (ref.)	G (ref.)
MFBA2V2012-***-R	2.0 \pm 0.20	1.25 \pm 0.20	0.85 \pm 0.20	0.50 \pm 0.30	1.05	1.00	1.45

Part marking: No marking
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ± 0.1 millimeters unless stated otherwise
Pad layout dimensions are reference only
Traces or vias underneath the inductor is not recommended

Packaging information (mm)

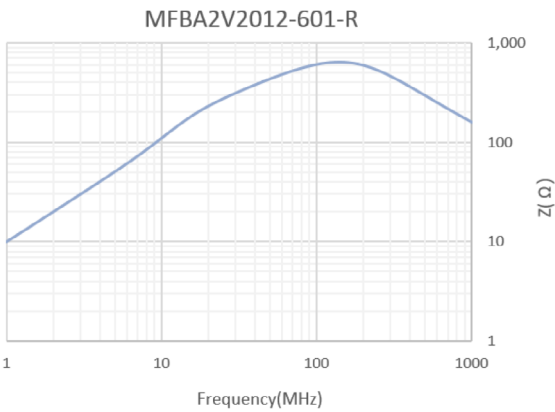
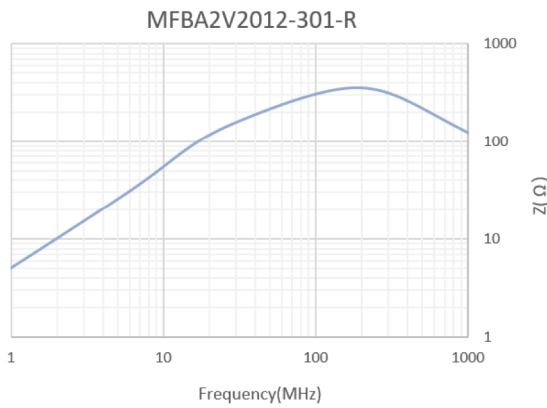
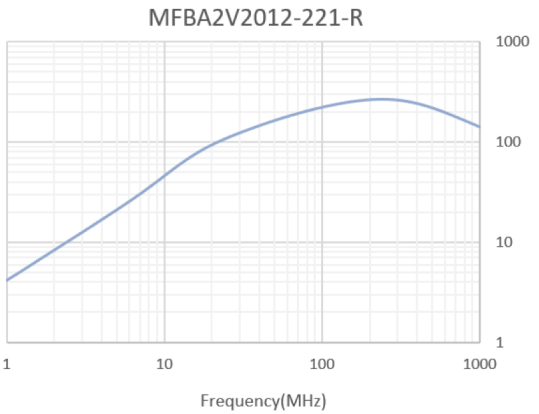
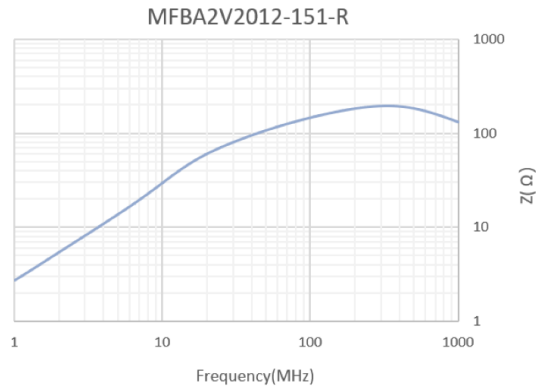
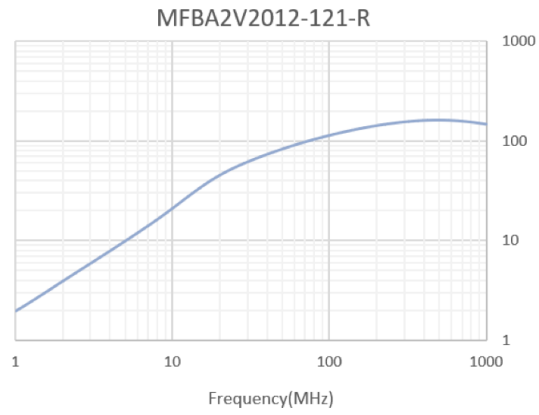
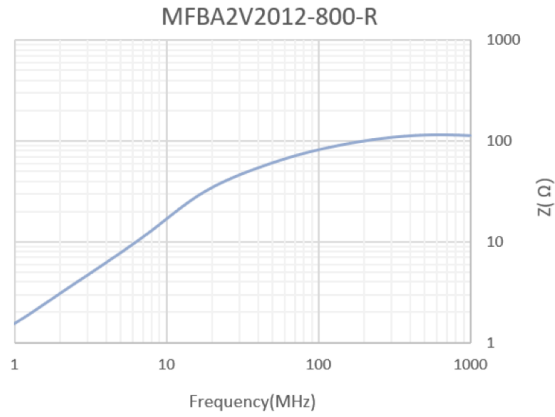
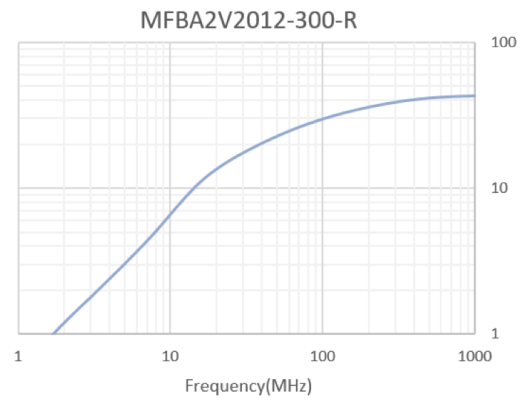
Drawing not to scale

Supplied in tape and reel packaging, 4000 parts per 7" diameter reel (EIA-481 compliant)



B_0	2.10 ± 0.05
A_0	1.30 ± 0.05
K_0	0.95 ± 0.05
P	4.0 ± 0.10
t	0.95 ± 0.05

Impedance vs frequency



Solder reflow profile

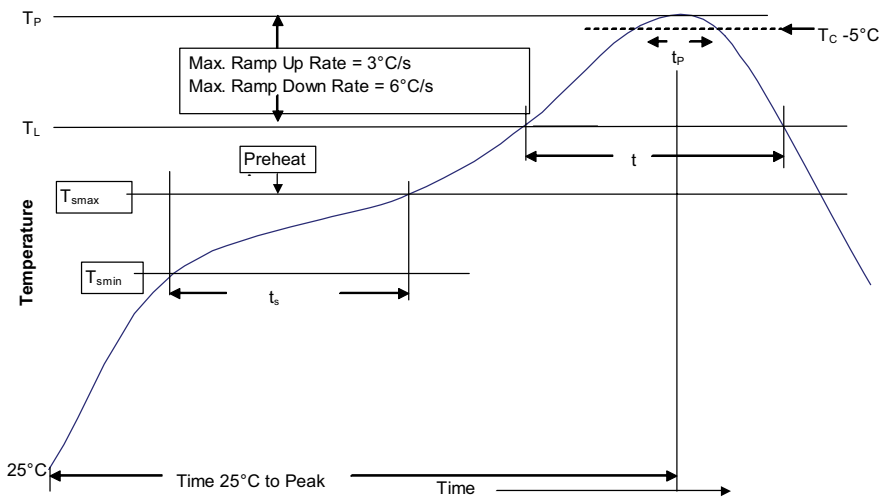


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T _L to T _p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T _L)	183 °C	217 °C
Time (t _L) maintained above T _L	60-150 seconds	60-150 seconds
Peak package body temperature (T _p)*	Table 1	Table 2
Time (t _p)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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